ne<mark>x</mark>peria

Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <u>http://www.nxp.com</u>, <u>http://www.philips.com/</u> or <u>http://www.semiconductors.philips.com/</u>, use <u>http://www.nexperia.com</u>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use **salesaddresses@nexperia.com** (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia





Product data sheet

1. Product profile

1.1 General description

Two NPN transistors and high-speed switching diode connected in totem pole configuration in a small SOT457 (SC-74) Surface-Mounted Device (SMD) plastic package.

1.2 Features

- Two general-purpose transistors and one high-speed switching diode as driver
- Totem pole configuration
- Application-optimized pinout
- Internal connections to minimize layout effort
- Space-saving solution
- Reduces component count

1.3 Applications

MOSFET driver

1.4 Quick reference data

Table 1.Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per transist	tor					
V _{CEO}	collector-emitter voltage	open base	-	-	45	V
I _C	collector current		-	-	0.1	А
I _{CM}	peak collector current	single pulse; $t_p \leq 1 ms$	-	-	0.2	А
Diode (D1)						
I _F	forward current		-	-	-0.2	А
V _F	forward voltage	$I_{F} = -200 \text{ mA}$	<u>[1]</u> _	-	-1.1	V



2. Pinning information

Table	2. Pinning	l		
Pin	Symbol	Description	Simplified outline	Symbol
1	OUT	output		
2	GND	ground		
3	IN	input	0	
4	RC	collector resistor		
5	RC	collector resistor		
6	VCC	supply voltage		1 2 3
				<i>006aaa657</i>

3. Ordering information

Table 3. Ordering information				
Type number	Package			
	Name	Description	Version	
PMD9010D	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457	

4. Marking

Table 4.	Marking codes	
Type num	ber	Marking code
PMD9010	0	AA

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

			-		
Symbol	Parameter	Conditions	Min	Max	Unit
Transistor	1 (TR1)				
V _{CBO}	collector-base voltage	open emitter	-	50	V
V _{CEO}	collector-emitter voltage	open base	-	45	V
V_{EBO}	emitter-base voltage	open collector	-	5	V
I _C	collector current		-	0.1	А
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms	-	0.2	A

MOSFET driver

Table 5.	Limiting	values	continued
----------	----------	--------	-----------

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Transistor	2 (TR2)				
V _{CBO}	collector-base voltage	open emitter	-	50	V
V _{CEO}	collector-emitter voltage	open base	-	45	V
I _C	collector current		-	0.1	А
I _{CM}	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	0.2	А
I _{BM}	peak base current	single pulse; $t_p \leq 1 ms$	-	0.2	А
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	290	mW
			[2] _	325	mW
			[3]	400	mW
Diode (D1))				
l _F	forward current		-	-0.2	А
I _{FRM}	repetitive peak forward current	$t_p \le 1 ms; \delta \le 0.25$	-	-0.6	А
I _{FSM}	non-repetitive peak forward	square wave			
	current	$t_p = 1 \ \mu s$	-	-9	А
		t _p = 100 μs	-	-3	А
		t _p = 10 ms	-	-1.7	А
Device					
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

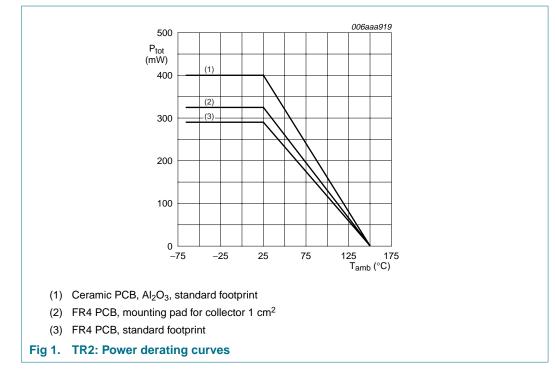
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on a ceramic PCB, AI_2O_3 , standard footprint.

PMD9010D

MOSFET driver



6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter Conditions Min Typ Max Un					
Transiste	or 2 (TR2)					
R _{th(j-a)} thermal resistance from junction to ambient	thermal resistance from	in free air	<u>[1]</u> _	-	430	K/W
		[2] _	-	385	K/W	
			[3] _	-	312	K/W

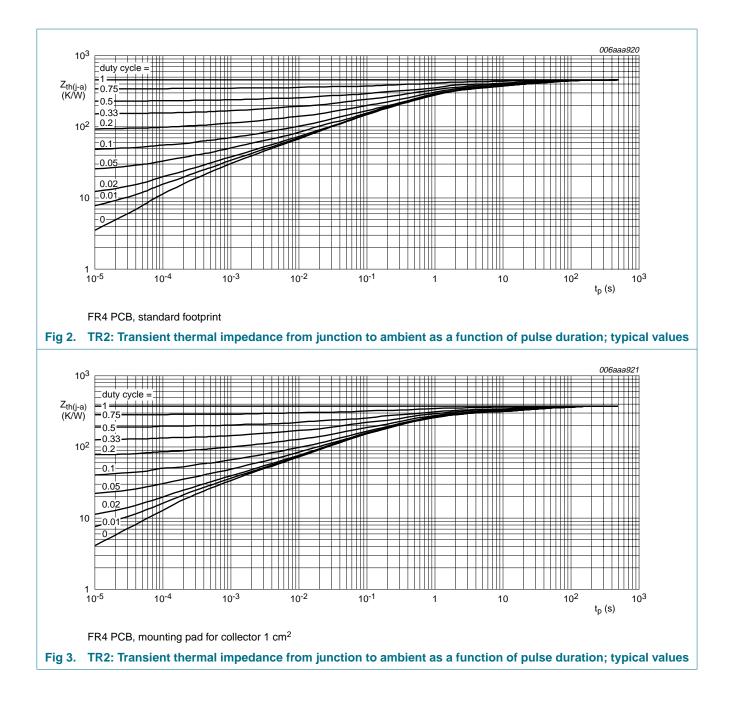
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

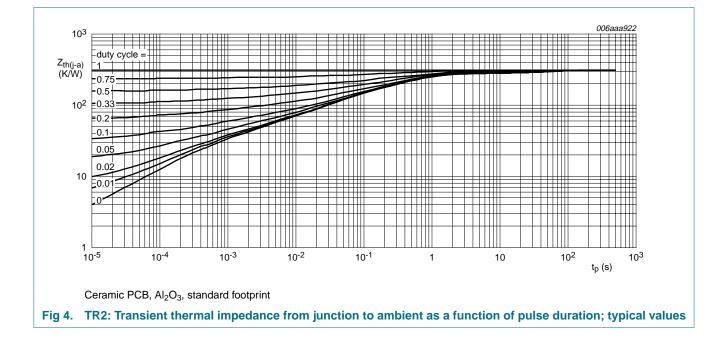
PMD9010D

MOSFET driver



PMD9010D

MOSFET driver



MOSFET driver

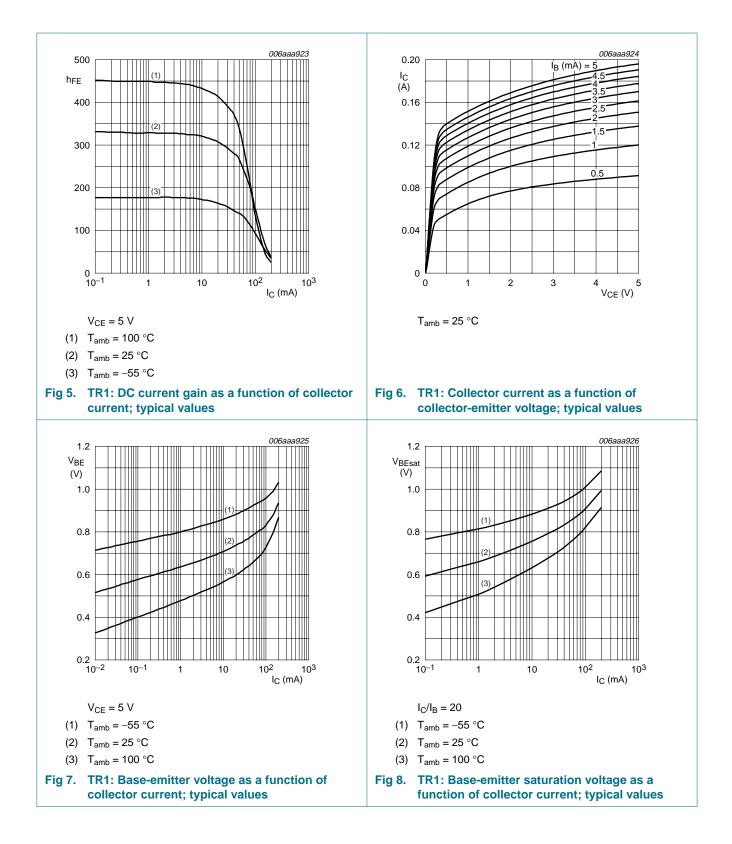
7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Transist	or 1 (TR1)						
I _{CBO}	collector-base cut-off current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$		-	-	100	nA
I _{CEO}	collector-emitter cut-off current	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A};$ $T_j = 150 \text{ °C}$		-	-	50	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 V; I_C = 0 A$		-	-	0.1	mA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ mA}$		200	290	450	
V _{CEsat}	collector-emitter saturation voltage	I_{C} = 10 mA; I_{B} = 0.5 mA		-	60	200	mV
V _{BEsat}	base-emitter saturation voltage	$I_{\rm C}$ = 10 mA; $I_{\rm B}$ = 0.5 mA		-	0.7	-	V
V _{BE}	base-emitter voltage	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$		-	660	-	mV
Transist	or 2 (TR2)						
I _{CBO}	collector-base cut-off	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$		-	-	15	nA
	current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A};$ T _j = 150 °C		-	-	5	μA
V _{CEsat} collector-emitter saturation voltage		$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$		-	60	200	mV
	$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$		-	200	400	mV	
		$I_{C} = 200 \text{ mA}; I_{B} = 20 \text{ mA}$		-	340	500	mV
V _{BEsat}	base-emitter	I_C = 10 mA; I_B = 0.5 mA		-	0.7	-	V
	saturation voltage	$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$		-	0.9	-	V
V _{BE}	base-emitter voltage	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$		610	660	710	mV
		$V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA}$		-	-	770	mV
Diode (D	01)						
VF	forward voltage	I _F = -200 mA	[1]	-	-	-1.1	V
TR2 and	D1						
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ mA}$		200	290	450	
		$V_{CE} = 5 \text{ V}; I_{C} = 100 \text{ mA}$		95	140	-	
		$V_{CE} = 5 \text{ V}; I_{C} = 200 \text{ mA}$		24	35	-	
Device							
t _d	delay time	$I_{C} = 0.05 \text{ A}; I_{B} = 2.5 \text{ mA}$		-	13	-	ns
t _r	rise time			-	77	-	ns
t _{on}	turn-on time			-	90	-	ns
t _s	storage time			-	853	-	ns
t _f	fall time			-	205	-	ns
t _{off}	turn-off time			-	1058	-	ns

[1] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02$.

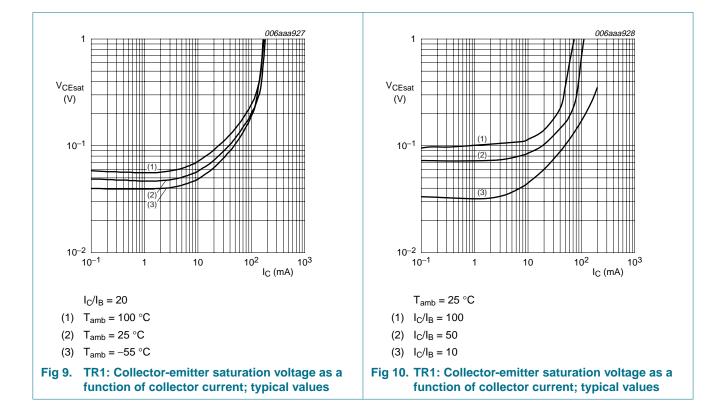
PMD9010D

MOSFET driver



PMD9010D

MOSFET driver

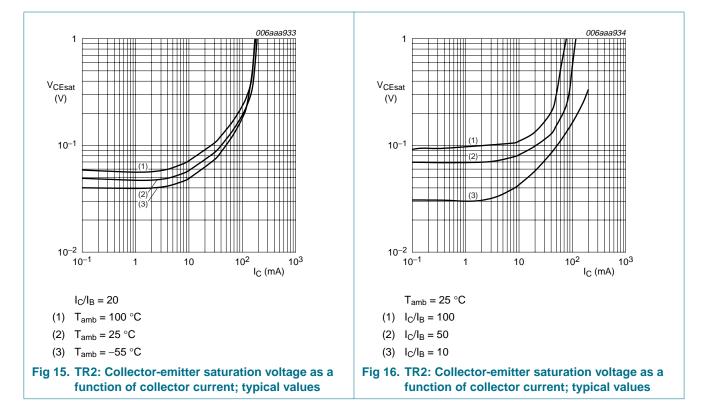


PMD9010D MOSFET driver

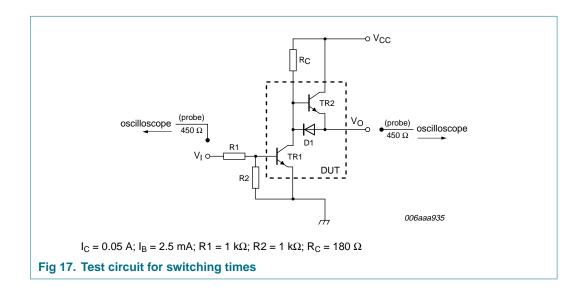
006a *006aaa930* 500 0.20 $I_B (mA) =$ 5 I_C (A) hFE 400 0.16 5 300 0.12 0.5 200 0.08 100 0.04 0 0 4 V_{CE} (V) 10-10 10² 10³ 1 2 3 1 0 5 I_C (mA) $T_{amb} = 25 \ ^{\circ}C$ $V_{CE} = 5 V$ (1) $T_{amb} = -55 \ ^{\circ}C$ (2) $T_{amb} = 25 \ ^{\circ}C$ (3) T_{amb} = 100 °C (4) T_{amb} = 125 °C (5) T_{amb} = 150 °C Fig 11. TR2 and D1: DC current gain as a function of Fig 12. TR2: Collector current as a function of collector current; typical values collector-emitter voltage; typical values *006aaa931 006aaa932* 1.2 1.2 V_{BE} VBEsat (V) (V) 1.0 1.0 0.8 0.8 0.6 0.6 0.4 0.4 0.2 0.2 10-2 ² 10³ I_C (mA) 10⁻¹)² 10³ I_C (mA) 10⁻¹ 10² 1 10 10^{2} 1 10 $V_{CE} = 5 V$ $I_C/I_B = 20$ (1) $T_{amb} = -55 \ ^{\circ}C$ (1) $T_{amb} = -55 \ ^{\circ}C$ (2) $T_{amb} = 25 \ ^{\circ}C$ (2) $T_{amb} = 25 \ ^{\circ}C$ (3) $T_{amb} = 100 \ ^{\circ}C$ (3) T_{amb} = 100 °C Fig 13. TR2: Base-emitter voltage as a function of Fig 14. TR2: Base-emitter saturation voltage as a collector current; typical values function of collector current; typical values

PMD9010D

MOSFET driver



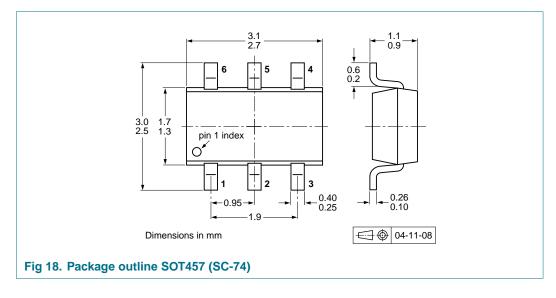
8. Test information



PMD9010D

MOSFET driver

9. Package outline



10. Packing information

Table 8.Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description		Packing quantity	
				3000	10000
PMD9010D	SOT457	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-165

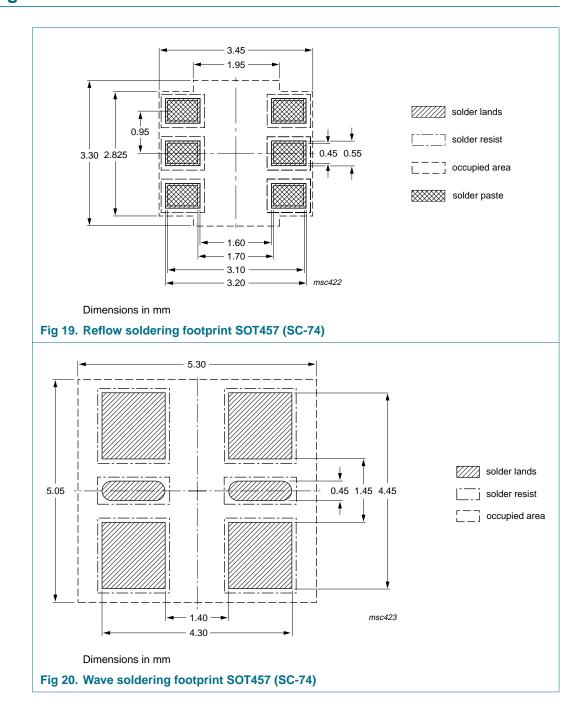
[1] For further information and the availability of packing methods, see <u>Section 14</u>.

[2] T1: normal taping

[3] T2: reverse taping

PMD9010D MOSFET driver

11. Soldering



MOSFET driver

12. Revision history

Table 9. Re	Revision history				
Document ID)	Release date	Data sheet status	Change notice	Supersedes
PMD9010D_1		20061120	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

13.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

13.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or

malfunction of a NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

14. Contact information

For additional information, please visit: http://www.nxp.com

For sales office addresses, send an email to: salesaddresses@nxp.com

PMD9010D_1

PMD9010D

MOSFET driver

15. Contents

1	Product profile 1
1.1	General description
1.2	Features
1.3	Applications 1
1.4	Quick reference data
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 2
6	Thermal characteristics 4
7	Characteristics
8	Test information 11
9	Package outline 12
10	Packing information
11	Soldering 13
12	Revision history 14
13	Legal information 15
13.1	Data sheet status 15
13.2	Definitions
13.3	Disclaimers
13.4	Trademarks 15
14	Contact information 15
15	Contents 16

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2006.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 20 November 2006 Document identifier: PMD9010D_1

